ASOCIATION CONNECTING LECTRONICS INDUSTRIES® INTERNATIONAL AND ADDRESS	Bannockbı	urn. Illinois. A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declara he declaration	tion of the s encompass	substances es all lowe	within the r level mat	manufacture erials for wh	er listed iten nich the ma	m. Note: nufacture	if the item is an as r has engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form T http://www.ipc.org/IPC-175x Distribution				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials a					als and Mfg	s and Mfg Information			
Supplier Information															
Company name*	Company unique ID			Unique ID Authority					Response Date*						
onsemi									2025-05-11						
ntact Name Title - Contact				I			Phone - Contact*				Email - Contact*				
Product-Env-Stewards Product Env			nviro Compliance			NA				Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Repr			presentative			Phone - Representative*				Email - Representative*					
Product-Env-Stewards Product			oduct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Da	te Version Manufacturing Site		ring Site	W	eight*	UOM	Unit Type		
	FDN8650	1LZ	FET 60V 116.0 mOhm SSOT3			2025-05-11]	РВВ		10	.811	mg	Each	
Manufacturing Proccess Information	1		•					<u>,</u>					·		
Terminal Plating / Grid Array Materi	erial Terminal Base A		Alloy	oy J-STD-020 MSL Ratin		Peak Pro	Process Body Temperature Max Time		ime at Peak	ak Temperature Number		ber of Reflow Cyc	eles		
Matte Tin (Sn) - annealed CU Alloy		U Alloy		1		260 C		30		seconds 3					
Comments															
level 1 - maximum time at peak temperature o	luring solo	dering is 10-3	0 seconds												
For more information regarding material con	position p	lease refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.306	mg	Supplier	Silicon (Si)	7440-21-3		0.306	mg
Die Attach	0.054	mg		Bismaleimide Resin	proprietary data		0.0089	mg
			Supplier	Other Additive Agents	Proprietary Data		0.0019	mg
			Supplier	Silver (Ag)	7440-22-4		0.0432	mg
Lead Frame	3.699	mg	Supplier	Silver (Ag)	7440-22-4		0.015	mg
			Supplier	Zinc (Zn)	7440-66-6		0.005	mg
			Supplier	Iron (Fe)	7439-89-6		0.088	mg
			Supplier	Copper (Cu)	7440-50-8		3.59	mg
			Supplier	Phosphorus (P)	7723-14-0		0.001	mg
Mold Compound-Black	6.41	mg	Supplier	Zinc borate	1332-07-6		0.2243	mg
			Supplier	Phenol, polymer with 1,4- bis(methoxymethyl)benzene	26834-02-6		0.2564	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.641	mg
			Supplier	Carbon Black (C)	1333-86-4		0.032	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		5.2562	mg
Plating	0.306	mg	Supplier	Tin (Sn)	7440-31-5		0.306	mg
Wire Bond - Cu	0.036	mg	Supplier	Copper (Cu)	7440-50-8		0.036	mg